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Part Number: [0736443008](#)
Status: **Active**
Overview: [hdm](#)
Description: 2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location B, Polarizing Key Position E, 144 Circuits

Documents:
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

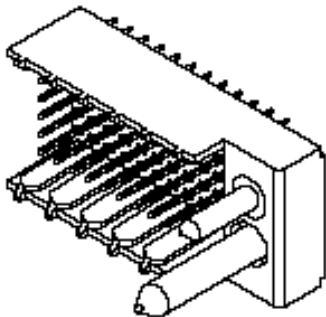
CSA LR19980
UL E29179

General

Product Family Backplane Connectors
Series [73644](#)
Application Backplane
Comments Standard Press-Fit, Tin/Lead (SnPb)
Component Type PCB Header
Overview [hdm](#)
Product Name HDM®
Style N/A

Physical

Circuits (Loaded) 144
Circuits (maximum) 144
Color - Resin Black, Natural
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part Yes
Material - Metal Phosphor Bronze, Stainless Steel
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Number of Columns 24
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length (in) 0.138 In
PC Tail Length (mm) 3.50 mm
PCB Locator No
PCB Retention Yes
PCB Thickness Recommended (in) 0.098 In
PCB Thickness Recommended (mm) 2.50 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.079 In
Pitch - Mating Interface (mm) 2.00 mm
Pitch - Term. Interface (in) 0.079 In
Pitch - Term. Interface (mm) 2.00 mm
Plating min: Mating (µin) 30
Plating min: Mating (µm) 0.75
Plating min: Termination (µin) 15
Plating min: Termination (µm) 0.375
Polarized to PCB No



Series

image - Reference only

EU RoHS
Not RoHS Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73644Series](#)

Mates With
73632 HDM PLUS® Board-to-Board Daughtercard Receptacle. 73780 HDM® Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global	
Description	Product #
Flat Rock Tooling for	0622013700
Pneumatic Press	
HDM® Backplane	0621001400
Insertion Signal	
Contact Tool	
HDM® Backplane	0622005703
Insertion Head for	
144 Positions	
Extraction Tool	0621001000

Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0818
Sales Drawing	SDA-73644-****

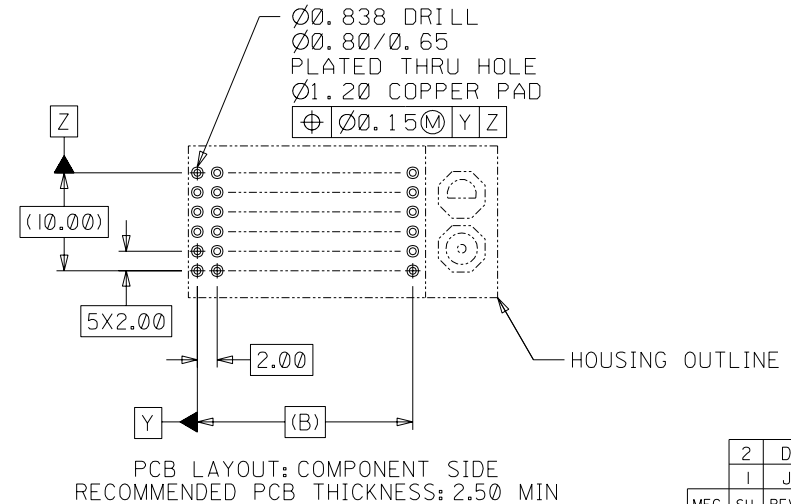
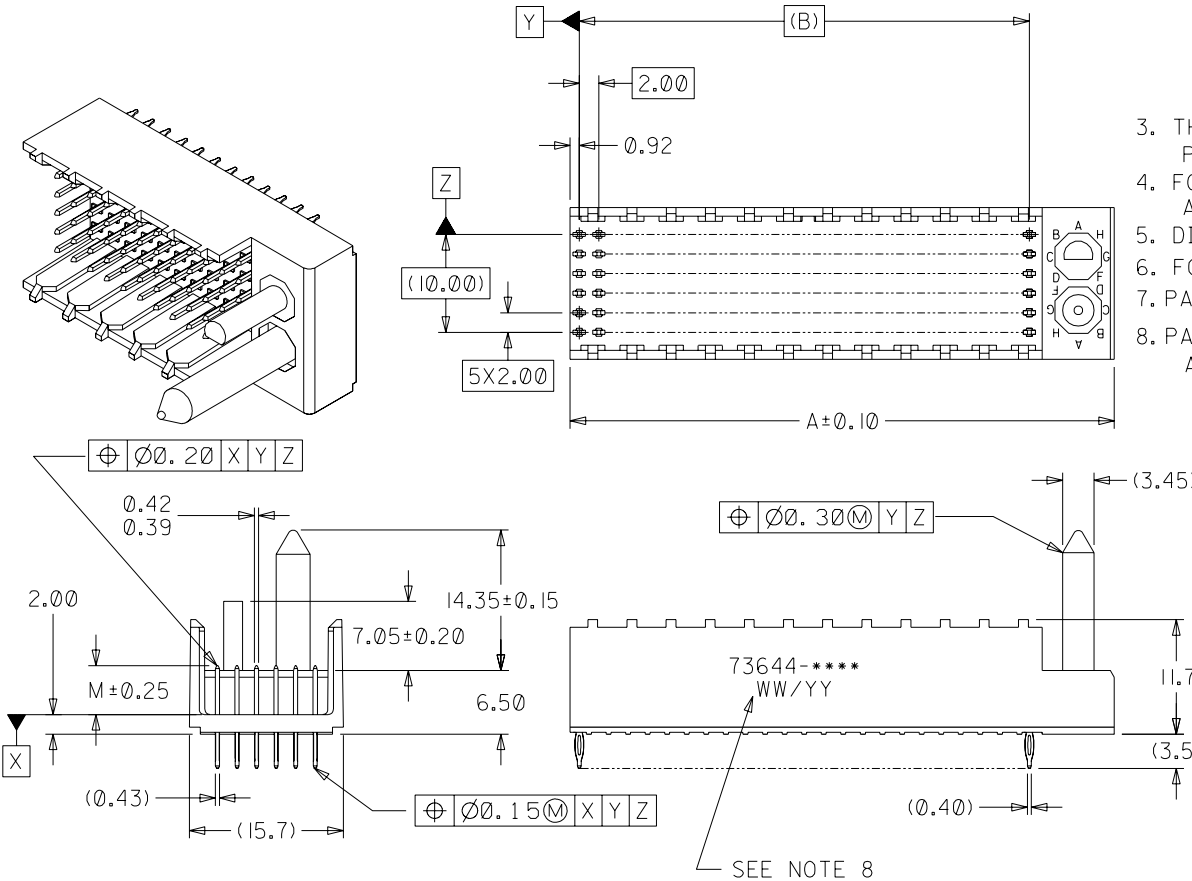
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This document was generated on 05/14/2010

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NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK, TERMINAL - PHOSPHOR BRONZE.
2. FINISHES: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; NICKEL (Ni) AND GOLD FLASH OVERALL SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MIN. THICKNESS; SELECTIVE TIN/LEAD (Sb/Pb) IN TAIL AREA; NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73670-9999.
4. FOR MIXED CONTACT MATING LENGTHS, CONSULT FACTORY FOR AVAILABILITY.
5. DIMENSIONS ARE IN MILLIMETERS.
6. FOR SPECIFIC MATERIAL NUMBERS, REFER TO SHEET 2.
7. PACKAGE PER PK-70873-0818.
8. PARTS MARKED WITH PART NUMBER AND DATE CODE, ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.



2	D
1	J
MFG.	SH.
REV.	

PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN

DIMENSIONS SHOWN (METRIC) INCH

UNLESS OTHERWISE SPECIFIED
TOLERANCES: ANGULAR ± 1/2°

	INCH	METRIC
3 PLACE	± N/A	---
2 PLACE	± N/A	± 0.05
1 PLACE	---	± 0.10

DRAFT WHERE APPLICABLE MUST
REMAIN WITHIN DIMENSIONS

DRWG. BY	JRR	CHK'D. BY	SMR
APP'D. BY	CAB	SCALE	2 : 1

REVISIONS ONLY ON CAD SYSTEM

TITLE

SALES ASSY, HDM BACKPLANE MODULE, POLAR/GUIDE OPTION	
MOLEX INCORPORATED LISLE, ILL. 60532	SHEET NO. 1 OF 2
PART NO. SEE CHART	DATE 96/12/18

FILE NAME S73644X1 DGN	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.	DIV. DA	SIZE B
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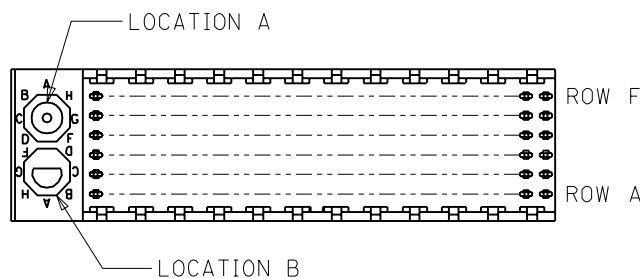
10		9	8	7	6		7364
F	MATERIAL NUMBER	NUMBER OF SIGNAL CONTACTS	PLATING		DIM "A"	DIM "B"	DIM "M"
	73644-00**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	5.00
	73644-01**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	5.50
	73644-02**	72	SELECTIVE GOLD/GOLD FLASH		31.60	22.00	6.00
	73644-10**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	5.00
	73644-11**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	5.50
	73644-12**	144	SELECTIVE GOLD/GOLD FLASH		55.60	46.00	6.00
E	73644-20**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	5.00
	73644-21**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	5.50
	73644-22**	72	SELECTIVE GOLD/SELECTIVE TIN-LEAD		31.60	22.00	6.00
	73644-30**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	5.00
	73644-31**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	5.50
	73644-32**	144	SELECTIVE GOLD/SELECTIVE TIN-LEAD		55.60	46.00	6.00

MATERIAL NUMBER ASSIGNMENT

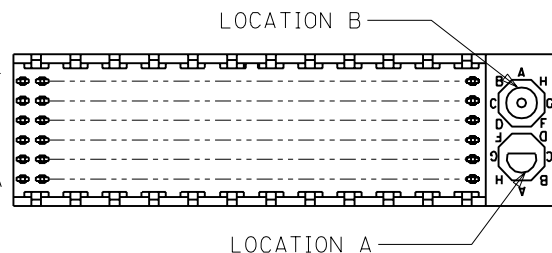
73644- * * * *

0 = 72-CIRCUIT, GOLD/GOLD FLASH
1 = 144-CIRCUIT, GOLD/GOLD FLASH
2 = 72-CIRCUIT, GOLD/TIN-LEAD
3 = 144-CIRCUIT, GOLD/TIN-LEAD

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0 = 5.00 MATING LENGTH
1 = 5.50 MATING LENGTH
2 = 6.00 MATING LENGTH
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REF. MATERIAL NUMBER 73644-0009
GUIDE PIN IS IN LOCATION A
POLARIZING KEY IS IN LOCATION B. POSITION F



REF. MATERIAL NUMBER 73644-0008
GUIDE PIN IS IN LOCATION B
POLARIZING KEY IS IN LOCATION A, POSITION E

NUMBER	GUIDE POST LOCATION	POLAR KEY POSITION
00	B	A
01	A	
02	B	B
03	A	
04	B	C
05	A	
06	B	D
07	A	
08	B	E
09	A	
10	B	F
11	A	
12	B	G
13	A	
14	B	H
15	A	
16	B	N/A
17	A	
18	N/A	

[illegible]



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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